

# PREFACE

Dear Distinguished Delegates and Guests,

The 4<sup>th</sup> International Conference on Computer-Aided Design, Manufacturing, Modeling and Simulation (CDMMS2014) was held in Chongqing, China, from September 13-15, 2014, serving as a platform for expertise exchange. CDMMS2014 had drawn the attention of researchers from various disciplines: CAD, CAM, Manufacturing, Mechanical Engineering, Modeling and simulation, etc.

Persons who attended the conference were engineers, scientists, managers of various companies and professors of the universities abroad and home. We have had record number of submission 746 this year. From which 229 papers have been accepted for presentation at the conference and will be published by TTP, in Applied Mechanics and Materials (AMM) Journal (ISSN: 1660-9336), which is online available in full text via the platform [www.scientific.net](http://www.scientific.net). AMM should be indexed by EI according the previous TTP index results.

We express our special gratitude to all the members of the General Committee Chairs, Program Committee Chairs, Technical Program Committee and Steering Committee who worked so hard to prepare the conference and who supported the conference so professionally.

The 4<sup>th</sup> International Conference on Computer-Aided Design, Manufacturing, Modeling and Simulation (CDMMS2014) is organized by Hunan Institute of Engineering, Zhejiang Gongshang University, Nanyang Technological University, Shanghai Jiao Tong University, and sponsored by National Natural Science Foundation of China (NSFC). Their kind support makes CDMMS2014 become possible. Especially, we should thank the TTP.

Finally, we would like to thanks all the authors, speakers and participants of this conference for taking part in and contributing to the International Conference on Computer-Aided Design, Manufacturing, Modeling and Simulation.

We hope you have a unique, rewarding and enjoyable week at CDMMS2014 in Chongqing, China.

With our warmest regards,

CDMMS2014 Organizing Committees  
September 13-15, 2014  
Chongqing, China

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